MTP SERIES KEY SWITCHES

FEATURES

- Totally sealed process compatible.
- Excellent tactile feed-back (snap dome).
- Shock & vibration resistance.
- SPST momentary action.

| G | SENERAL SPECIFICATIONS | |
|-------------------|---|---|
| | LECTRICALS | |
| IC IN UNTICE | Contact rating: nsulation resistance: Dielectric withstanding voltage: Contact resistance: ife: | 50 mA @ 12 VDC 100 megohms minimum at 100 VDC 250 VAC for 1 minute 100 milliohms maximum 100,000 cycles minimum |
| | IECHANICALS, THERMALS | |
| CIFICATIONS SUBJE | Operating force: Plunger travel: Shock: /ibration: Operating temperature range: Storage temperature range: | 160±50 grams .010 +.008 /004" (.25 +0.2 / -0.1mm) Withstands 80 g for 3 cycles in each of 6 directions (18 cycles total) Withstands 10-55 Hz. for 2 hours in each of 3 mutually perpendicular planes, including direction of stem travel. -20°C to +70°C -30°C to +80°C |
| S | OLDERING | |
| N | Vave soldering: /anual soldering: Solvent washing: | 255°C max. for 5 seconds maximum. Preheat - 100°C max. for 45 sec. max. 350°C ± 10°C for 3 seconds maximum Washable. |
| M | IATERIALS | |
| C A T S | Case: Cover: Actuator: Ferminals: Shorting Contact: Internal seal: | Polyetherimide PBT Acetal Silver plated brass Silver plated copper alloy Nitrile |

